

SOA-1020-110-YY-27dB

Broad-band Semiconductor Optical Amplifier



Features:

- High gain up to 27dB
- Broad band (970-1080nm) gain
- Strong linear polarization
- RoHS compliance

Applications:

- Swept-source, tunable lasers
- · Booster optical amplifiers
- Optical preamplifiers
- Optical coherence tomography (OCT)

SPECIFICATIONS										
Test conditions: CW operation, chip temperature 25°C, the case is mounted on room temperature heatsink										
Parameters	Min.	Тур.	Max.	Unit						
Operating current (lop)		550	600	mA						
Forward voltage @ lop		1.6	1.8	V						
Gain										
Small signal gain ^{1 2}	27	30		dB						
Gain mean wavelength ¹	1005	1020	1035	nm						
Gain bandwidth¹ @ -3dB	90	110		nm						
Amplitude of gain spectrum dip ¹		3	6	dB						
Gain saturation output power² @ -3dB	10	15		dBm						
Noise figure ³ ***		8		dB						
Amplified Spontaneous Emis	sion (AS	E)*								
ASE optical power ex fiber from each port	7	10		mW						
ASE mean wavelength	1010	1020	1030	nm						
ASE bandwidth @ -3dB	90	110		nm						
Amplitude of ASE spectrum dip		4	7	dB						
ASE ground state maximum position	1030	1040	1050	nm						
ASE excited state maximum position	960	970	980	nm						
ASE** spectrum ripples³ (RMS in 1nm range, 10pm resolution)		0.2	0.5	dB						
ASE rise time		0.15		ns						
ASE fall time		0.5		ns						
ASE polarization extinction ratio (PER) at each port	15	20		dB						

at -25dBm input optical power

³ at wavelength of ASE maximum **** NF=10log₁₀(2p_{ASE}/Ghv) [D.Baney *et al.*, Optical Fiber Techn. **6**, 122 (2000)]

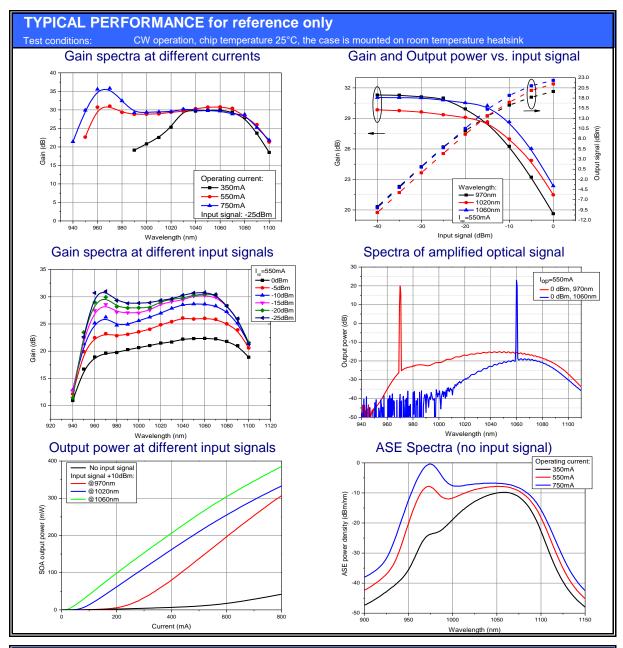
ABSOLUTE MAXIMUM RATINGS							
Parameters	Min.	Max.	Unit				
SOA reverse voltage	-	2	V				
SOA CW forward current	-	800	mA				
Input optical power	-	20	dBm				
Thermo Electric Cooler current	-	3	Α				
Thermo Electric Cooler voltage	-	4	V				
Fiber bend radius	3	-	cm				
Chip operating temperature range	10	40	°C				
Case operating temperature range	0	70	°C				
Storage temperature range	-40	85	°C				

^{*} without input light

² at wavelength of gain maximum

^{**} from output port



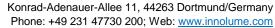


Part Number Identification

YY: Optical fiber type PM – PM980 fiber HI – HI1060 fiber

Example: SOA-1020-110-PM-27dB

NOTE: Innolume product specifications are subject to change without notice





THERMISTOR	SPECIFIC	PECIFICATION FIBER SPECIFICATION				
Parameters	Value	Unit	Parameters	HI1060	PM980	Unit
Thermistor type	NTC	-	Numerical aperture (Typical)	0.14	0.12	
Resistance @25°C	10 ± 0.1	kOhm	Cutoff wavelength	920±50	900±70	nm
Beta 0-50°C	3375±1%	K	Mode-field diameter @1060nm	6.2±0.3	6.6±0.3	μm
·		Cladding diameter	125±1	125±1	μm	
		Coating diameter	245±15	245±15	μm	
R-T CURVE Lengt		Length (each port)	1.0 ± 0.1	1.0 ± 0.1	m	
30000			Connector FC/APC (narrow key)		key)	
25000			Connector alignment to the PANDA fiber			
CONNECTOR KEY The output light is poly the slow axis of PM fill				0 1	-	

10000

FAST SLOW AXIS

the slow axis of PM fiber.

DIMENSIONS (in mm) Pin identification: TEC "+" Thermistor 3 Output 4 Thermistor 8,9 6 8 9 SOA anode "+" 10 SOA cathode "-" 11 12 Case 13 TEC "-"

AND OPERATING INSTRUCTIONS

The light emitted from this device is invisible and can be harmful to the human eye. Avoid looking directly into the fiber connector when the device is in operation. Proper laser safety eyewear must be worn during operation with open connector.

Absolute Maximum Ratings may be applied to the device for short period of time only. Exposure to maximum ratings for extended period of time or exposure to more than one maximum rating may cause damage or affect the reliability of the device. Operating the device outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum forward current cannot be exceeded.

A proper heatsink for the device on thermal radiator is required. The device must be mounted on radiator with 4 screws (bolt down in X-style fashion with initial torque set to 0.075Nm and final X-style bolt down at 0.15Nm) or with clamps. The deviation from flatness of radiator surface must be less than 0.05mm. It's recommended using of Indium foil or thermal conductive and soft material between bottom of the case and heatsink for thermal interface. It's undesirable to use thermal grease for this.

Avoid back reflection to the device. It may give impact on the device performance in aspects of spectrum and power stability. It also may cause fatal facet damage. Using of optical isolators is highly recommended to block back reflection.

Do not pull the fiber. Do not bend a fiber with a radius smaller than 3 cm. Fiber tip should always be protected from any contamination or damage during the process of installation. After removing the dust-preventing cap covered at fiber tip, carefully clean fiber tip by wiping through one direction using optical lens cleaning paper or cotton swab dabbed with Isr Propanol or Ethyl alcohol. Operate the device with clean fiber connector only.

Electrostatic discharge is the primary cause of unexpected product failure. Take extreme precaution to prevent ESD. During device installation, ESD protection has to be maintained - use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling the product







